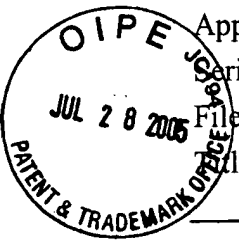


S/N 10/606,539

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Applicant: Kie Y. Ahn et al.

Examiner: James Mitchell

Serial No.: 10/606,539

Group Art Unit: 2813

Filed: June 26, 2003

Docket No.: 303.533US2

Title: COMPACT SYSTEM MODULE WITH BUILT-IN THERMOELECTRIC COOLING

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

This responds to the Office Action dated on March 23, 2005. Please amend the above-identified patent application as follows.

This response is accompanied by a Petition, as well as the appropriate fee, to obtain a one-month extension of the period for responding to the Office Action, thereby moving the deadline for response from June 23, 2005 to July 23, 2005.